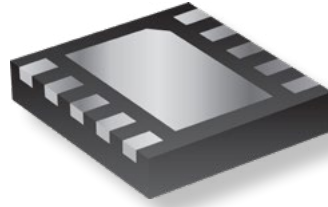




PRODUCT CHANGE NOTIFICATION

CHIP DIODES



Bourns® Model CDDFN10-3304NA TVS Diode Array

Additional Sub-Supplier for Wafer

Riverside, California – June 14, 2019 – In order to support our fast-growing demand, secure continuity of supply and provide maximum flexibility to our customers, Bourns will add a second wafer foundry for the Bourns® Model CDDFN10-3304NA TVS Diode Array.

There will be no change to the fit, form, function, quality or reliability of the products. Traceability will be maintained through the lot code and date code. The product marking and label will be unchanged. China will remain the country of origin. The manufacturing process at Bourns will also remain the same. Evaluation samples and qualification data are available upon request.

Affected Part Number

[CDDFN10-3304NA](#)

Deliveries of such products may occur 180 days after the date of this notice, unless your company has been notified otherwise.

Implementation dates are as follows:

Date that deliveries of products from the second wafer foundry will begin: **January 1, 2020**

First date code using the above changes: **2001**

If you have any questions or need additional information, please feel free to contact [Customer Service/Inside Sales](#).